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## FGB20N60SFD\_F085 600V, 20A Field Stop IGBT

## Features

- · High current capability
- Low saturation voltage: V<sub>CE(sat)</sub> = 2.2V @ I<sub>C</sub> = 20A
- High input impedance
- · Fast switching
- Qualified to Automotive Requirements of AEC-Q101
- RoHS complaint

## Applications

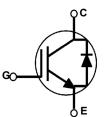
- Inverters, SMPS, PFC, UPS
- Automotive Chargers, Converters, High Voltage Auxiliaries

# G E C

## **General Description**

Using novel field-stop IGBT technology, Fairchild's new series of field-stop IGBTs offers the optimum performance for automotive chargers, inverters, and other applications where low conduction and switching losses are essential.





## **Absolute Maximum Ratings**

Symbol	Description		Ratings	Units	
V <sub>CES</sub>	Collector to Emitter Voltage		600	V	
V <sub>GES</sub>	Gate to Emitter Voltage		$\pm 20$	V	
1.	Collector Current	@ T <sub>C</sub> = 25°C	40	А	
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 100°C	20	А	
I <sub>CM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	60	A	
I <sub>F</sub>	Diode Forward Current	@ T <sub>C</sub> = 25°C	20	A	
	Diode Forward Current	@ T <sub>C</sub> = 100°C	10	А	
I <sub>FM(1)</sub>	Pulsed Diode Maximum Forward Current		60	А	
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	208	W	
	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	83	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C	
Τ <sub>L</sub>	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

## **Thermal Characteristics**

Symbol	Parameter	Ratings	Units
$R_{\theta JC}(IGBT)_{(2)}$	Thermal Resistance, Junction to Case	0.6	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case	2.6	°C/W
Symbol	Parameter	Тур.	Units
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (PCB Mount)(2)	75	°C/W

Device N	larking	Device	Package	Packaging Type	Qty per Tube		Max Qty per Box		
FGB20N	60SFD	FGB20N60SFD_F085	TO-263	Tube	5	0ea	-	-	
					1		L		
Electric	al Cha	racteristics of the	<b>IGBT</b> T <sub>C</sub> = 25°C	C unless otherwise noted					
Symbol		Parameter	Test C	Conditions	Min.	Тур.	Max.	Units	
Off Charac	teristics								
BV <sub>CES</sub>	Collector	to Emitter Breakdown Volta	ge V <sub>GE</sub> = 0V, I <sub>C</sub> =	= 250μA	600	-	-	V	
ΔBV <sub>CES</sub> ΔT <sub>J</sub>	Temperat Voltage	ure Coefficient of Breakdow	$v_{GE} = 0V, I_C =$	$V_{GE} = 0V, I_C = 250 \mu A$ $V_{GE} = 0V, I_C = 250 \mu A$		0.79	-	V/ºC	
I <sub>CES</sub>	Collector	Cut-Off Current	$V_{CE} = V_{CES}, V_{CES}$	/ <sub>GE</sub> = 0V	-	-	250	_	
			ICES at 80%*	BVCES, 150°C	-	-	250	μA	
I <sub>GES</sub>	G-E Leak	age Current		ICES at 80%*BVCES, 150°C $V_{GE} = V_{GES}, V_{CE} = 0V$		-	±400	nA	
					1			I.	
On Charac	1	abold Voltage		- ) (	4.0	4.0	6 5	11	
V <sub>GE(th)</sub>	G-E Inre	shold Voltage		$I_{C} = 250 \mu A, V_{CE} = V_{GE}$		4.8 2.2	6.5 2.85	V V	
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage		0 02	$I_{\rm C} = 20$ A, $V_{\rm GE} = 15$ V		2.2	2.85	V	
02(000)			$T_{\rm C} = 20$ , $V_{\rm GE}$ $T_{\rm C} = 125^{\rm o}$ C	$I_{\rm C}$ = 20A, $V_{\rm GE}$ = 15V, $T_{\rm C}$ = 125°C		2.4	-	V	
Dynamic C	haractoris	tice							
C <sub>ies</sub>	Input Cap				_	940	1250	pF	
C <sub>oes</sub>		apacitance	V <sub>CE</sub> = 30V, V <sub>G</sub>	<sub>GE</sub> = 0V,	-	110	146	pF	
C <sub>res</sub>	-	Transfer Capacitance	f = 1MHz	f = 1MHz		40	53	pF	
	I				I	11			
Switching					[			1	
t <sub>d(on)</sub>		Delay Time			-	10	13	ns	
t <sub>r</sub>	Rise Time	-			-	16	21	ns	
t <sub>d(off)</sub>		Delay Time	$V_{CC} = 400V, I_{CC}$		-	90	120	ns	
t <sub>f</sub> ⊏	Fall Time	Switching Loss	R <sub>G</sub> = 10Ω, V <sub>G</sub> Inductive Load	d, T <sub>C</sub> = 25 <sup>o</sup> C	-	24	36	ns	
E <sub>on</sub>		Switching Loss				0.31	0.41	mJ mJ	
E <sub>off</sub> E <sub>ts</sub>		tching Loss			-	0.13	0.21	mJ	
		Delay Time			_	12	16	ns	
t <sub>d(on)</sub> t <sub>r</sub>	Rise Time	,				12	21	ns	
r t <sub>d(off)</sub>		2 Delay Time	V <sub>CC</sub> = 400V, I	o = 20A	_	95	126	ns	
t <sub>f</sub>	Fall Time	, -	R <sub>G</sub> = 10Ω, V <sub>G</sub>	<sub>E</sub> = 15V,	-	28	43	ns	
E <sub>on</sub>		Switching Loss	Inductive Load	d, T <sub>C</sub> = 125ºC	-	0.45	0.60	mJ	
E <sub>off</sub>		Switching Loss			-	0.21	0.38	mJ	
E <sub>ts</sub>		tching Loss			_	0.66	0.88	mJ	
Q <sub>g</sub>	Total Gate	e Charge			-	63	95	nC	
Q <sub>ge</sub>		mitter Charge	$V_{CE} = 400V, I_{CE}$	<sub>C</sub> = 20A,	-	7	11	nC	
Q <sub>gc</sub>	Cata ta C	collector Charge	— V <sub>GE</sub> = 15V		-	32	48	nC	

Electric	Electrical Characteristics of the Diode $T_c = 25^{\circ}C$ unless otherwise noted							
Symbol	Parameter	Test Condition	Min.	Тур.	Max	Units		
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 10A	T <sub>C</sub> = 25°C	-	1.9	2.5	V	
			T <sub>C</sub> = 125 <sup>o</sup> C	-	1.7	-		
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>ES</sub> = 10A, dI <sub>ES</sub> /dt = 200A/μs	T <sub>C</sub> = 25°C	-	111	-	ns	
			T <sub>C</sub> = 125°C	-	204	-		
Q <sub>rr</sub>	Diode Reverse Recovery Charge	$1_{\rm ES} = 10$ , $0_{\rm ES} = 200$ / $\mu$ s	T <sub>C</sub> = 25°C	-	174	244	nC	
			T <sub>C</sub> = 125 <sup>o</sup> C	-	463	-		

#### Notes:

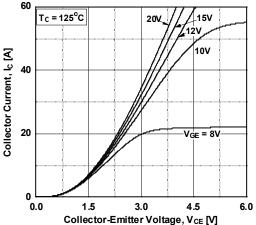
1: Repetitive rating: Pulse width limited by max. junction temperature

2:Rthjc for D2-PAK: according to Mil standard 883-1012 test method.

Rthja for D2-PAK: according to JESD51-2, test method environmental condition and JESD51-3, low effective thermal conductivity test board for leaded surface mount package. thermal measurements. JESD51-2: Integrated Circuits Thermal Test Method Environmental Conditions - Natural Convection (Still Air).

### **Typical Performance Characteristics** Figure 1. Typical Output Characteristics 60 $T_C = 25^{\circ}C$ /\_15V 20 12 Collector Current, Ic [A] 40 10 20 VGE = 8V 0 0.0 1.5 3.0 4.5 6.0 Collector-Emitter Voltage, VCE [V] **Figure 3. Typical Saturation Voltage** Characteristics 60 Common Emitter V<sub>GE</sub> = 15V T<sub>C</sub> = 25°C \_\_\_\_ Collector Current, I<sub>c</sub> [A] Collector Current, lc [A] T<sub>C</sub> = 125°C---40 20 0 0 2 3 5 4 Collector-Emitter Voltage, VCE [V] Figure 5. Saturation Voltage vs. Case **Temperature at Variant Current Level** Common Emitter V<sub>GF</sub> = 15V Collector-Emitter Voltage, V<sub>œ</sub> [V] 40A 3 20A 2

**Figure 2. Typical Output Characteristics** 



**Figure 4. Transfer Characteristics** 

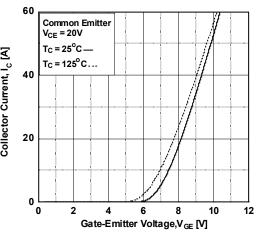
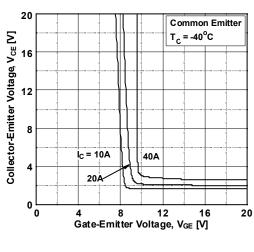


Figure 6. Saturation Voltage vs. V<sub>GE</sub>



1

25

50

75

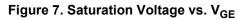
Collector-EmitterCase Temperature, T<sub>C</sub> [°C]

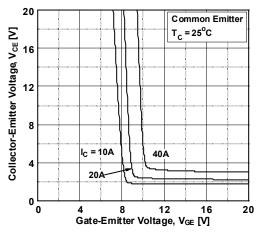
Ic = 10A

100

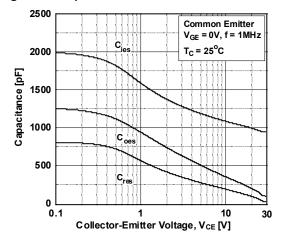
125

## **Typical Performance Characteristics**











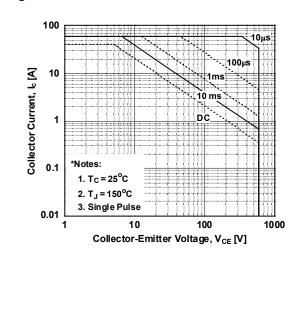


Figure 8. Saturation Voltage vs. V<sub>GE</sub>

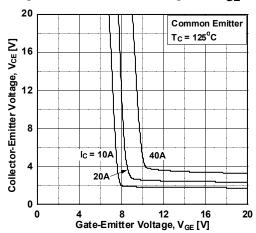


Figure 10. Gate charge Characteristics

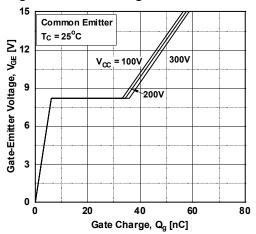
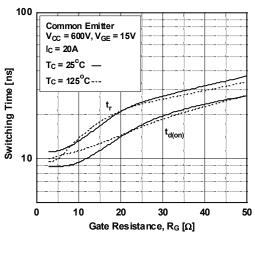
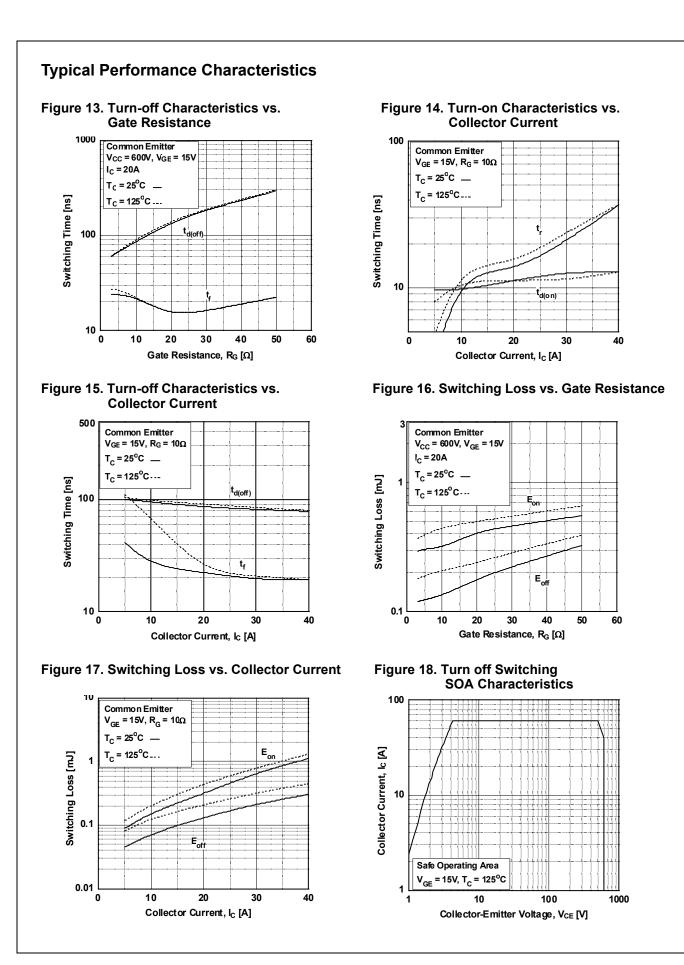
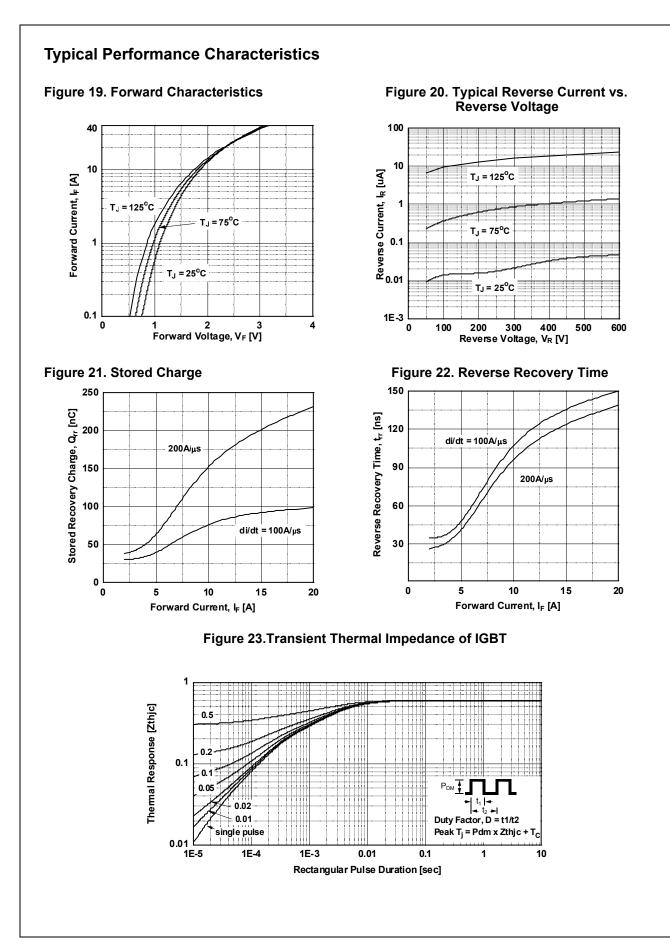


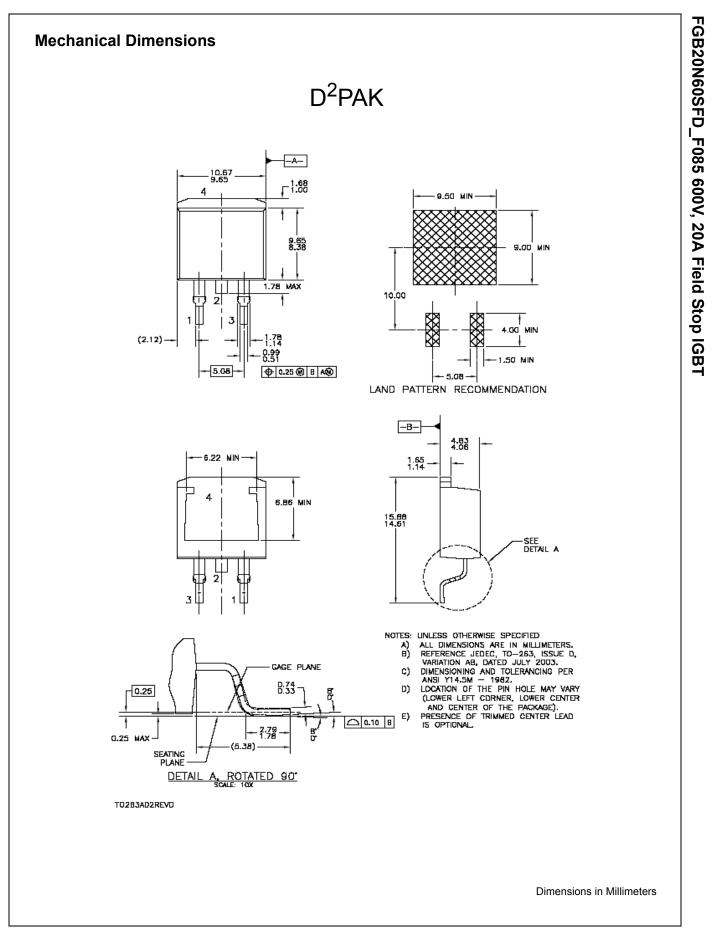
Figure 12. Turn-on Characteristics vs. Gate Resistance





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